

# Global Wafer Backside Grinding Service Market Growth (Status and Outlook) 2026-2032

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## Abstracts

The global Wafer Backside Grinding Service market size is predicted to grow from US\$ 136 million in 2025 to US\$ 396 million in 2032; it is expected to grow at a CAGR of 16.8% from 2026 to 2032.

Wafer backside grinding, also known as wafer thinning, is one of the semiconductor device manufacturing steps in which the wafer thickness is reduced to allow for the stacking and high-density packaging of integrated circuits (ICs). Integrated circuits are produced on semiconductor wafers that have undergone several processing steps. Silicon wafers commonly used today are around 750 micrometers thick to ensure maximum mechanical stability and avoid warping during high-temperature processing steps. Smart cards, USB memory sticks, smartphones, handheld music players and other ultra-compact electronics would not exist in their current form without minimizing the size of the various components in all dimensions. Therefore, before wafer dicing (where the individual microchips are separated), the back side of the wafer is 'ground' or 'thinned'. Today, wafers thinned to 75 to 50 micrometers are common.

The Asia-Pacific region (especially China, South Korea, Japan, and Taiwan) is the main market for wafer thinning services in the world. These regions have strong semiconductor manufacturing capabilities and are major semiconductor production bases in the world. The increased demand in North America and Europe in the fields of high-performance computing and artificial intelligence has also brought growth opportunities to the wafer thinning services market.

With the continuous development of technologies such as integrated circuits, 5G, artificial intelligence, and the Internet of Things, the demand for wafer thinning technology is also continuing to grow. Wafer thinning not only helps to reduce the size

of chips, but also improves their heat dissipation performance and enhances the performance-to-power ratio. However, with the continuous increase in wafer size and the increase in integration, the demand for high-end thinning equipment is increasing, and the procurement and maintenance costs of these equipment are high. Despite certain technical and cost challenges, the market outlook remains very optimistic as the technology matures and its applications diversify.

LPI (LP Information)' newest research report, the “Wafer Backside Grinding Service Industry Forecast” looks at past sales and reviews total world Wafer Backside Grinding Service sales in 2025, providing a comprehensive analysis by region and market sector of projected Wafer Backside Grinding Service sales for 2026 through 2032. With Wafer Backside Grinding Service sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US\$ millions of the world Wafer Backside Grinding Service industry.

This Insight Report provides a comprehensive analysis of the global Wafer Backside Grinding Service landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyses the strategies of leading global companies with a focus on Wafer Backside Grinding Service portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms' unique position in an accelerating global Wafer Backside Grinding Service market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for Wafer Backside Grinding Service and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Wafer Backside Grinding Service.

This report presents a comprehensive overview, market shares, and growth opportunities of Wafer Backside Grinding Service market by product type, application, key players and key regions and countries.

### **Segmentation by Type:**

Conventional Grinding

## Chemical Mechanical Polishing (CMP)

### **Segmentation by Application:**

Consumer Electronics

Automotive Electronics

Computer and Data Center

Others

### **This report also splits the market by region:**

Americas

United States

Canada

Mexico

Brazil

APAC

China

Japan

Korea

Southeast Asia

India

Australia

## Europe

Germany

France

UK

Italy

Russia

## Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analyzing the company's coverage, product portfolio, its market penetration.

Syagrus Systems

Optim Wafer Services

Silicon Valley Microelectronics, Inc.

SIEGERT WAFER GmbH

NICHIWA KOGYO

Integra Technologies

Valley Design

Helia Photonics

Aptek Industries

Enzan Factory Co., Ltd.

Phoenix Silicon International

Prosperity Power Technology Inc.

Huahong Group

Winstek

CHIPBOND Technology Corporation

Ceramicforum

Integrated Service Technology Inc.

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